

	SPECIFICATIONS	
CUSTOMER	· PTC	
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MASS PRODUCTION CODE	NPC1602W	RP-JWA-I
SAMPLE VERSION	01	
SPECIFICATIONS EDITION	001	
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PACKAGING NO. (Ver.)	:	
	Customer Approved	Date: POWERTIP 2014.05.20 JS RD APPROVED
Approved	Checked	Designer
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 Preliminary specificatio Specification for sample 	- ·	
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Appendix :

1. LCM drawing

Note : For detailed information please refer to IC data sheet : SITRONIX---ST7066U-0A



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	16*2 Characters
LCD Type	PBT , Negative , Transmissive
Driver Condition	LCD Module : 1/16 Duty , 1/5 Bias
Viewing Direction	6 O'clock
Weight	TBD
Interface	6800-series 8-bit parallel
Driver IC	ST7066U
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	85.0 (L) * 30.0 (W) *12.7(H)	mm
Viewing Area	66.0 (L) * 16.0 (W)	mm
Active Area	56.2 (L) * 11.5 (W)	mm
Character Size	2.95mm * 5.55mm	mm
Character Pitch	3.55mm * 5.95mm	mm

Note : For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V_{DD}	-	-0.3	7.0	V
LCD Driver Supply Voltage	V_{LCD}	-	Vdd -10.0	VDD +0.3	V
Input Voltage	V _{IN}	-	-0.3	V _{DD} +0.3	V
Operating Temperature	Τ _{ΟΡ}	-	-20	70	°C
Storage Temperature	T _{ST}	-	-30	80	°C
Storage Humidity	H_{D}	Ta<60 ℃	-	90	%RH

1.4 DC Electrical Characteristics

					Ta = 1	25° ℃
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	V_{DD}	-	4.5	5.0	5.5	V
"H" Input Voltage	VIH		0.7 Vdd	-	Vdd	V
"L" Input Voltage	V _{IL}		-0.3	-	0.6	V
"H" Output Voltage	V _{OH}	IOH=-0.1mA	3.9	-	Vdd	V
"L" Output Voltage	V _{OL}	IOL=0.1mA	-	-	0.4	V
Supply Current	I _{DD}	V _{DD} = 5.0 V ,Vo=TBD V Pattern=check Patten *1	-	TBD	TBD	mA
		-20°C (VDD= 5.0 V)	TBD	TBD	TBD	
LCM Driver Voltage	Vo	25°C (Vdd= 5.0 V)	TBD	TBD	TBD	V
		70°C (VDD= 5.0 V)	TBD	TBD	TBD	

NOTE: *1 The Maximum current display



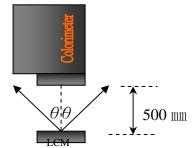
1.5 Optical Characteristics

			LCD Panel	: 1/16 Dut	ty,1/5 Bia	as,V _{LCD} :	= TBDV	• Ta =25℃
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Boopopoo Timo	Rise	tr		-	TBD	TBD	ma	Note 2
Response Time	Fall	tf	-	-	TBD	TBD	ms	Note 2
	Тор	θ+		-	TBD	-		
Viewing angle	Bottom	θ-	- C <u>≥</u> 2.0 -	-	TBD	-	Deg	Note 1
range	Left	θL		-	TBD	-		Note 1
	Right	θR		-	TBD	-		
Contrast Ra	tio	С	-	-	TBD	-	-	Note 3
Average Bright (with LCD)		IV		TBD	TBD	-	cd/m ²	
Wavelength (with LCD) Uniformity *1		λр	IF= TBD mA	TBD	TBD	TBD	nm	Note 4
		∆B		70	-	-	%	

Note 4 :

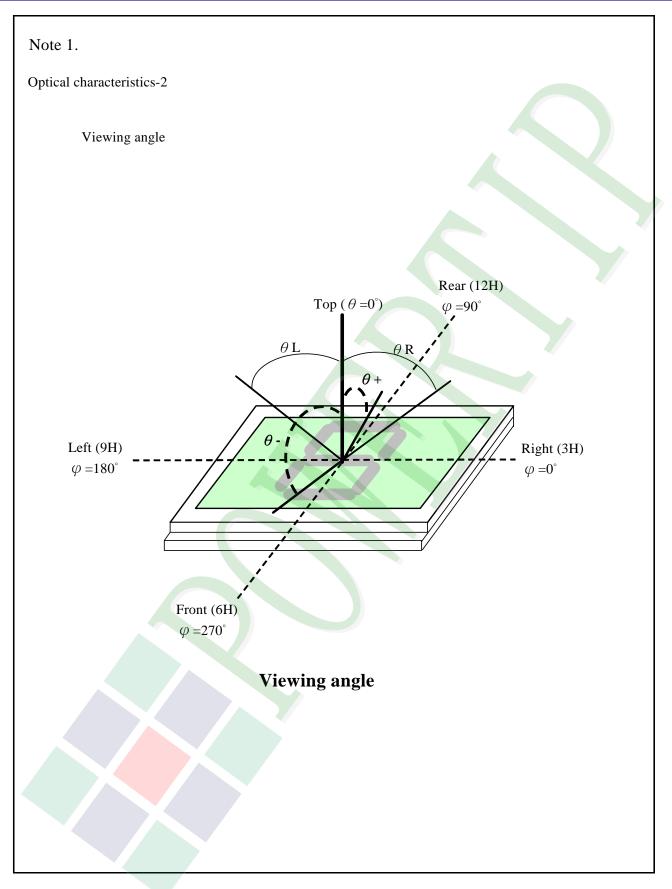
- 1 : △B=B(min) / B(max) * 100%
- 2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: 500 ± 50 mm \rightarrow (θ = 0°)
 - c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
 - d : The uncertainty of the C.I.E coordinate measurement ± 0.01 , Average Brightness $\pm 4\%$



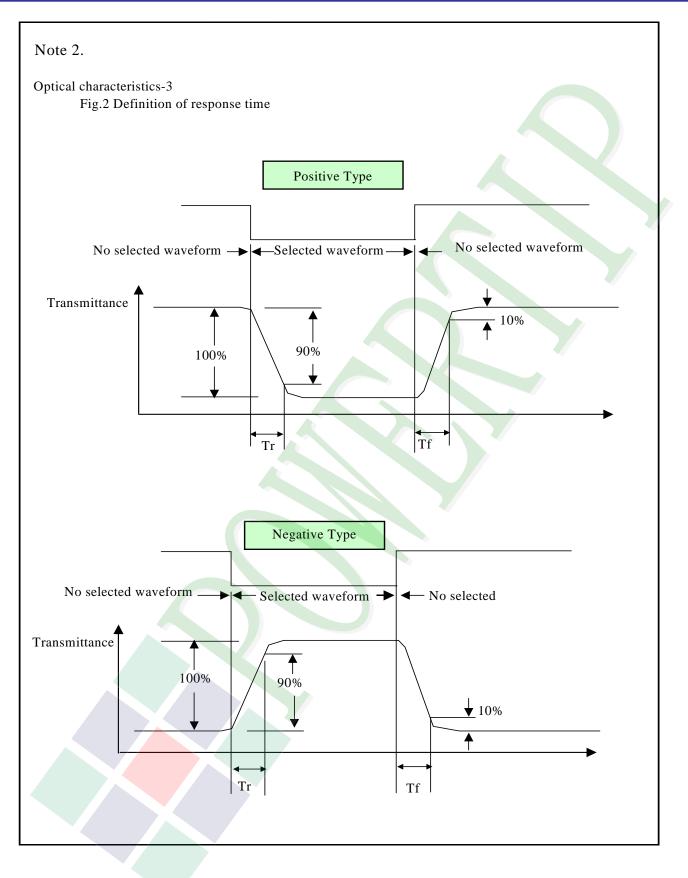


Colorimeter=BM-7 fast

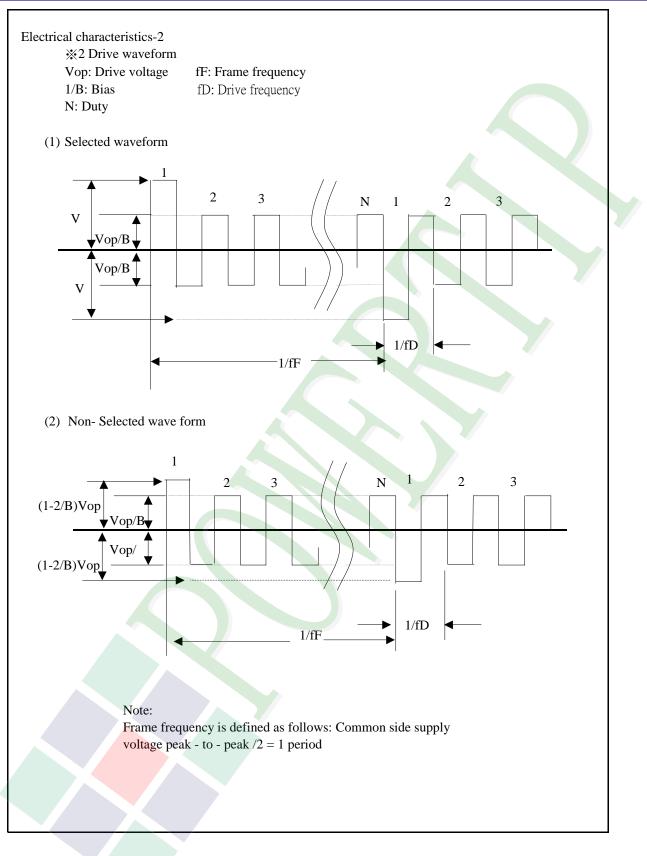




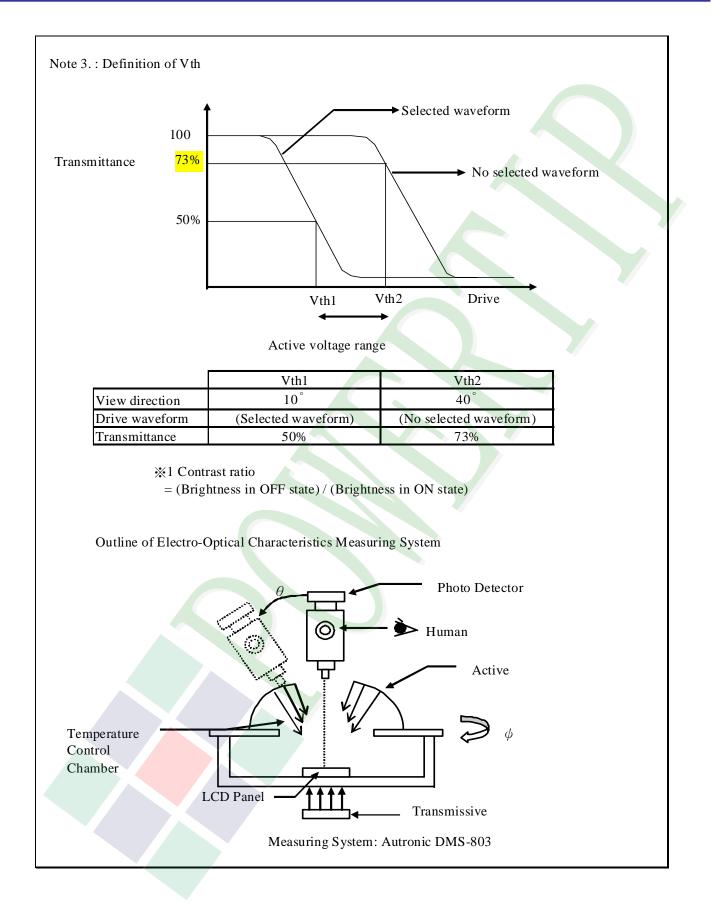














1.6 Backlight Characteristics

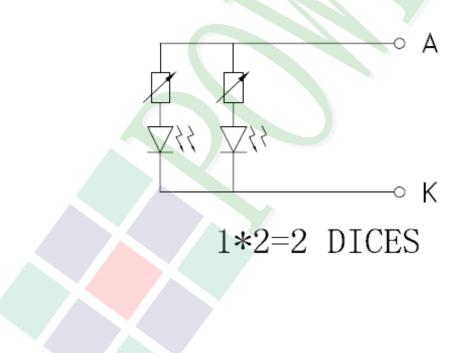
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25 ℃	-	40	mA
Reverse Voltage	VR	Ta =25 ℃	-	5	V
Power Dissipation	PD	Ta =25 ℃	-	132	W

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		3.0	3.3	3.6	V
Average Brightness (without LCD)	IV	IF= 40 mA	1200	1500	Y -	cd/m ²
CIE Color Coordinate	Х		0.26	0.29	0.31	
(Without LCD)	Y		0.26	0.29	0.31	-
Color			White	7		

Internal Circuit Diagram:





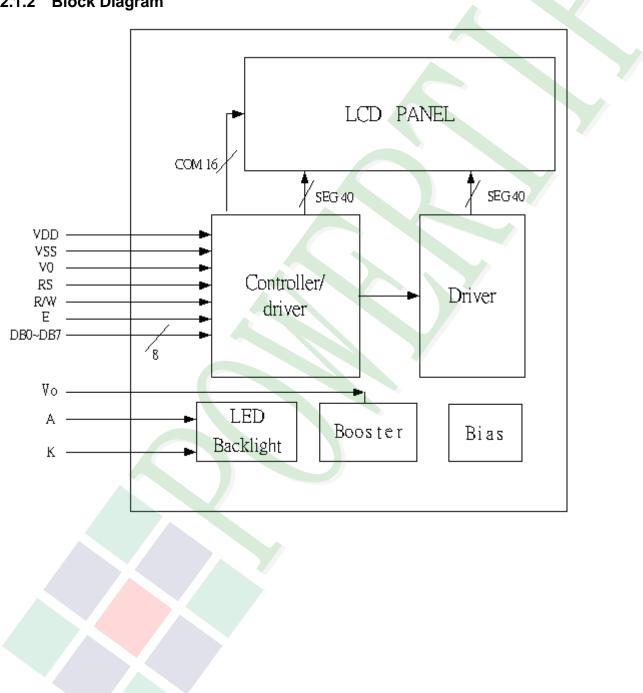
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram



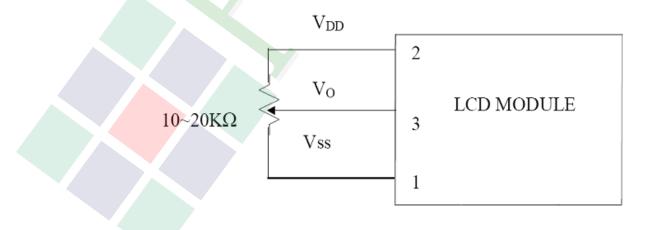


2.2 Interface Pin Description

Pin No.	Symbol	Signal Description
1	V _{SS}	Power Supply (Vss=0)
2	V _{DD}	Power Supply (5V)
3	Vo	Operating voltage for LCD
		Register Selection input
4	RS	High = Data register
4	K0	Low = Instruction register (for write)
		Busy flag address counter (for read)
5	R/W	Read/Write signal input is used to select the read/write mode
5	r./ v v	High = Read mode, Low = Write mode
6	E	Start enable signal to read or write the data
7	DB0	Four low order bi directional three state data bus lines. Line for
8	DB1	Four low order bi-directional three-state data bus lines. Use for data transfer between the MPU and the LCD module.
9	DB2	These four are not used during 4-bit operation.
10	DB3	These four are not used during 4-bit operation.
11	DB4	
12	DB5	Four high order bi-directional three-state data bus lines. Used
13	DB6	for data transfer between the MPU and the LCD module.
14	DB7	DB7 can be used as a busy flag.

2.2.1 Application Notes

Contrast Adjust

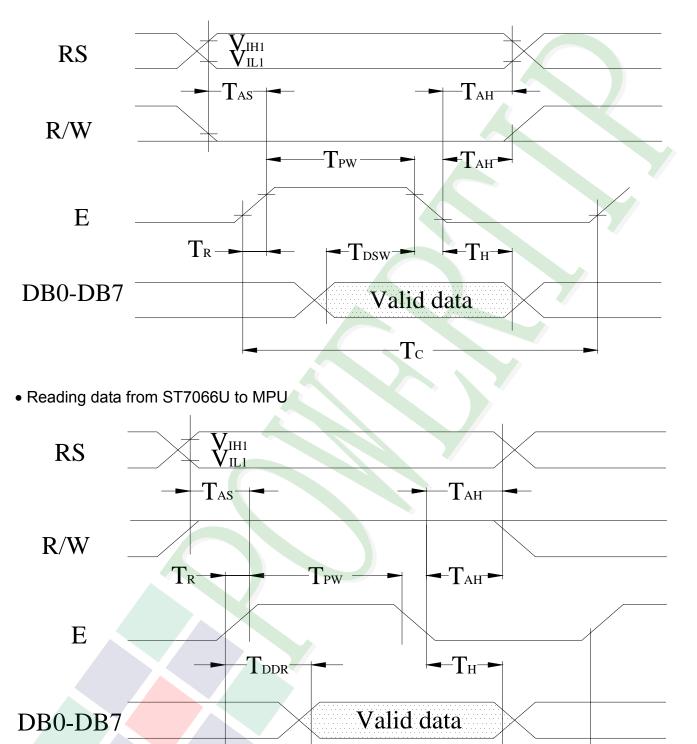


2.2.2 Refer Initial code



2.3 Timing Characteristics

• Writing data from MPU to ST7066U



-Tc



• Write Mode (Writing data from MPU to ST7066U)

				(\	/DD = 5V,	,Ta=25°C)
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
Tc	Enable Cycle Time	Pin E	1200	-	-	ns
T _{PW}	Enable Pulse Width	Pin E	140	-	4	ns
T_R, T_F	Enable Rise / Fall Time	Pin E	-	-	25	ns
T _{AS}	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
T _{AH}	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
T _{DSW}	Data Setup Time	Pins:DB0~DB7	40	-	-	ns
Т _н	Data Hold Time	Pins:DB0~DB7	10	-	-	ns

• Read Mode (Reading data from ST7066U to MPU)

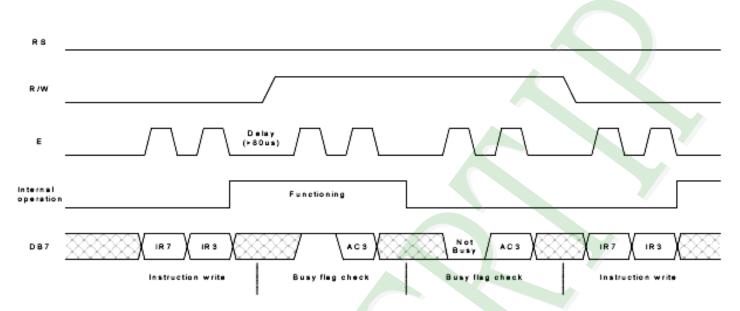
		-			VDD = 5V	/, Ia=25°C
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
T _C	Enable Cycle Time	Pin E	1200	-	-	ns
T _{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise / Fall Time	Pin E	-	I	25	ns
T _{AS}	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
T _{AH}	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
T_{DDR}	Data Setup Time	Pins:DB0~DB7		-	100	ns
Τ _Η	Data Hold Time	Pins:DB0~DB7	10	-	-	ns

חר



For 4-bit interface date, only four bus lines (DB4 to DB7) are used for transfer

Example of busy flag check timing sequence



For 8-bit interface date, all eight bus lines (DB0 to DB7) are used

Exa	mple of busy flag check timing sequence
RS	
R/W	
E	Delay (=80us)
internal operation	Functioning
D 6 7	Data Busy Busy Not Busy Data Instruction write Busy flag check Busy flag check Busy flag check Instruction write



2.4 Display Command

		Instruction Code									Description		
Instructions	RS	R/	DB	DB	DB	DB	DB	DB	DB	DB	Description	Time	
	К9	W	7	6	5	4	3	2	1	0		(270KHz)	
Clear											Write "20H" to DDRAM. and set		
Display	0	0	0	0	0	0	0	0	0	1	DDRAM address to "00H" from	1.52ms	
Display											AC.		
											Set DDRAM address to "00H"		
Return									1		from AC and return cursor to it's		
Home	0	0	0	0	0	0	0	0			original position if shifted.	1.52ms	
TIOITIC											The contents of DDRAM		
											are not changed.		
											Sets cursor move direction and		
Entry Mode	0	0	0	0	0	0	0	1	I/D	S	specifies display shift. These	37µs	
Set	U	U	Ŭ	0	Ŭ	U	U			0	operations are performed	υ ημο	
											during data write and read .		
Display											D=1 : entire display on		
ON/OFF	0	0	0	0	0	0	1	D	С	В	C=1 : cursor on	37 μ s	
											B=1 : cursor position on		
Cursor or											Set cursor moving and display		
Display	0	0	0 0	0	0	0	1	S/C	R/L	×	×	shift control bit, and the	37 μ s
Shift	Ŭ	Ū			Ū			0,0				the direction, without changing	• · p·•
											of DDRAM data.		
Function											DL: interface data is 8/4 bits		
Set	0	0	0 0	0	0	1	DL	N	F	×	×	NL: number of line is 2/1	37 μ s
											F: font size is 5×11/5×8		
Set					AC	AC	AC	AC	AC	AC	Set CGRAM address		
CGRAM	0	0	0	1	5	4	3	2	1	0	in address counter.	37 μ s	
Address													
Set				AC	AC	AC	AC	AC	AC	AC	Set DDRAM address		
DDRAM	0	0	1	6	5	4	3	2	1	0	in address counter.	37 μ s	
Address										-			
_											Whether during internal		
Read Busy			в	AC	AC	AC	AC	AC	AC	AC	operation or not can be		
Flag and	0	1	F	6	5	4	3	2	1	0	known by reading BF.	0 μ s	
Address											The contents of address		
											counter can also be read.		



Write Data to RAM	1	0	D 7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	37µs
Read Data from RAM	1	1	D 7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	37µs

Note:

Be sure the ST7066U is not in the busy state (BF=0) before sending an instruction from the MPU to the ST7066.

If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself.

Before checking BF, be sure to wait at least 80us.. Do not keep "E" always "High" for checking BF Refer to Instruction Table for the list of each instruction execution time .

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2.5 Character Pattern

NO.7066-0A

$\frac{10.71}{10.71}$						 						 		
67-64 63-60		0001	0010	0011	0100		0111	1000	1001	1010	1011		1110	1111
0000	CG RAM (1)													
0001	(2)													
0010	(3)													
0011	(4)													
0100	(5)													
0101	(6)													
0110	3													
0111	(8)													
1000	(1)													
1001	(2)													
1010	(3)													
1011	(4)													
1100	(5)													
1101	(6)													
1110	0													
1111	(8)													

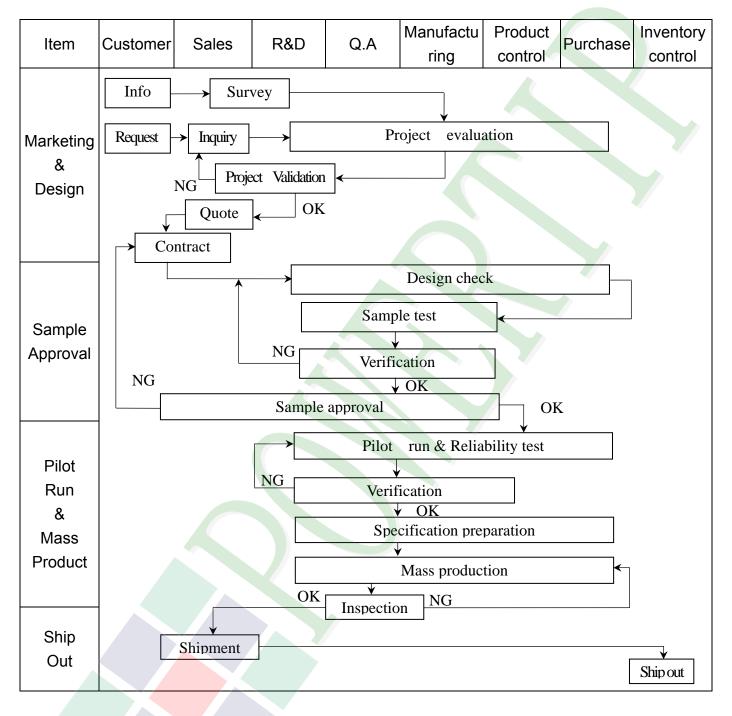
2.6 JUMPER

TBD



3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart





Item	Customer	Sales	R&D	Q.A	Manufact uring	Product control	Purchase	Inventory control
Sales Service	Info Analys	→ Claim -	[Trackin	Failure an Corrective			
Q.A Activity	13 Equipment calibration 4 Education And Train						es	

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3.2 **Inspection Specification**

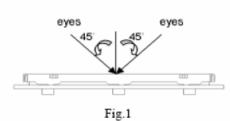
Scope : The document shall be applied to LCD Module for Monotype and Color STN(Ver. B01).

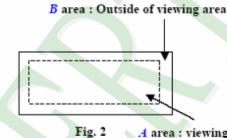
◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

- ◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample
- ◆Defect Level: Major Defect AQL:0.4 ; Minor Defect:AQL: 1.5.
- OUT Going Defect Level : Sampling .

Manner of appearance test :

- (1). The test be under 20W×2 fluorescent light ' and distance of view must be at 30 cm.
- (2). Standard of inspection : (Unit : mm)
- (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
- (4). Definition of area . (Fig. 2)





A area : viewing area

Specification:

NO	Item	Criterion	Level				
		1. 1 The part number is inconsistent with work order of Production.	Major				
01	Product condition	1. 2 Mixed production types.	Major				
		1.3 Assembled in inverse direction.	Major				
02	Quantity	. 1 The quantity is inconsistent with work order of production.					
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major				
		4. 1 Missing line character and icon.	Major				
		4. 2 No function or no display.	Major				
04	Electrical Testing	4. 3 Output data is error.	Major				
		4. 4 LCD viewing angle defect.	Major				
		4.5 Current consumption exceeds product specifications.	Major				



♦Spe	cification For Mono	type and Color STN :					(Ver.B01)		
NO	Item	C	Criteri	on			Level		
	Black or white dot 、scratch 、 contamination	 5. 1 Round type: 5. 1. 1 display only : • White and black spots on display ≤ 0. 30 mm, no more than 4 white or black spots present. • Densely spaced : NO more than two spots or lines within 3 mm. 							
		5. 1. 2 Non-display :							
	Round type	Dimension (diameter : Φ)	Acceptance (Q'ty) A area B area						
		Φ≤ 0.10		A area ept no dense	D	area			
	+ x ++	$0.10 < \Phi \leq 0.20$		3					
05	₩	$0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.30$		2	Ι	gnore	Minor		
	Φ=(x+y)/2	Total quantity		4					
	$\Psi^{-}(\mathbf{x} + \mathbf{y})/2$			4					
		5. 1. 3 Line type:							
	Line type	Dimension	Acceptance (Q'ty)			e (Q'ty)			
	Line type	Length (L) Width (W)		A area		B area			
	∽ / [‡] ^w	W≦		Accept no de	nse				
		$L \le 3.0$ $0.03 < W \le$	4						
	2	$L \le 2.5$ 0.05 $< W \le 0$. 075						
		W >0	. 075 As round type						
		Dimension		Acceptan	ce (Q				
		(diameter : Φ)		A area		B area	<u>i</u>		
		$\Phi \leq 0.20$	A	ccept no dense					
06	Polarizer	$0.20 < \Phi \leq 0.50$	3				Minor		
	Bubble	$0.50 < \Phi \le 1.00$	2			Ignore			
		$\Phi > 1.00$	0						
		Total quantity	4						
			<u> </u>						

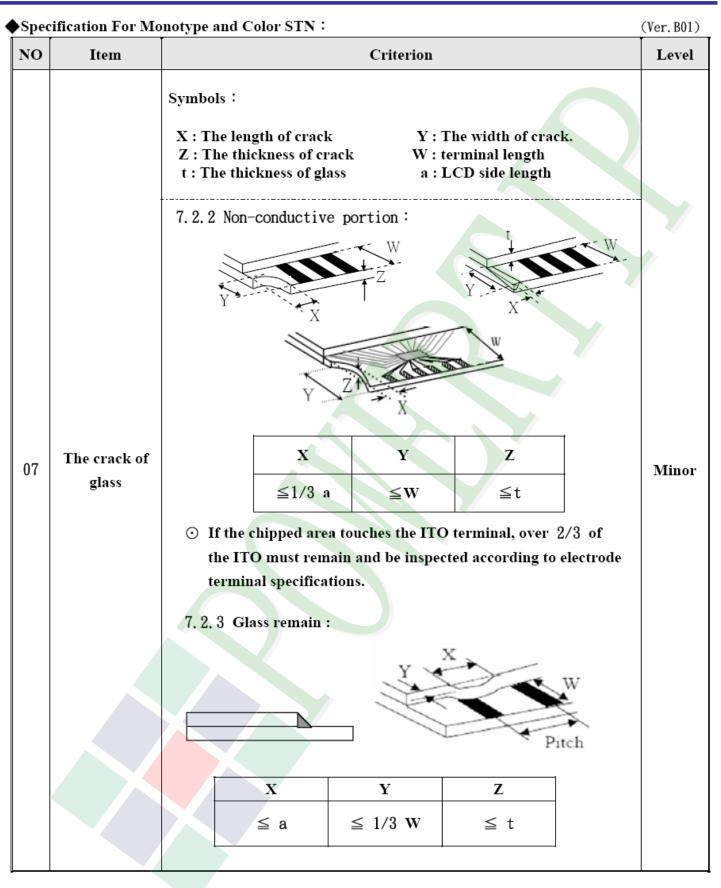


Specification For Monotype and Color STN : (Ver. B0							
NO	Item	Criterior	1	Level			
		Z : The thickness of crack W	: The width of crack. : terminal length : LCD side length				
		7.1 General glass chip: 7.1.1 Chip on panel surface and crac	ck between panels:				
			Z V X X				
07	The crack of glass		SP [NG]	Minor			
		Seal width	X Y				
		XY	Z				
		≤ a Crack can't enter viewing area	$\leq 1/2 t$				
		≤ a Crack can't exceed th half of SP width.	$e 1/2 t < \mathbf{Z} \leq 2 t$				



Spec	Specification For Monotype and Color STN : (Ver. B01)							
NO	Item	Criterion						
		Symbols : X : The length of crack Y : The width of crack. Z : The thickness of crack W : terminal length t : The thickness of glass a : LCD side length 7. 1. 2 Corner crack : X Z						
		XYZ $\leq 1/5$ aCrack can't enter viewing areaZ $\leq 1/2$ t						
07	The crack of glass	$ \leq 1/5 \text{ a} \begin{array}{c} \text{Crack can't exceed the} \\ \text{half of SP width.} \end{array} 1/2 \text{ t} < \text{Z} \leq 2 \text{ t} \end{array} \\ \hline 7.2 \text{ Protrusion over terminal :} \\ 7.2.1 \text{ Chip on electrode pad :} \end{array}$	Minor					
		X Y Z						
		Front \leq a \leq 1/2 W \leq t						
		Back Neglect						







Specification For Monotype and Color STN : (Ver. B01)							
NO	Item	Criterion	Level				
		8. 1 Backlight can't work normally.	Major				
08	Backlight elements	8. 2 Backlight doesn't light or color is wrong.	Major				
		8. 3 Illumination source flickers when lit.	Major				
		9. 1 Pin type must match type in specification sheet.	Major				
		9. 2 No short circuits in components on PCB or FPC.	Major				
09	General appearance	9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor				
		9. 4 The folding and peeled off in polarizer are not acceptable.	Minor				
		9.5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≦1.5 mm.	Minor				



4. RELIABILITY TEST

4.1	Reliability Test Condition (Ver.B01)							
NO.	TEST ITEM	TEST CONDITION						
1	High Temperature Storage Test	Keep in +80 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.						
2	Low Temperature Storage Test	Keep in $-30 \pm 2^{\circ}$ C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.						
3	High Temperature / High Humidity Storage Test	Keep in +60 °C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)						
4	Temperature Cycling Storage Test	$\begin{array}{cccc} -30^{\circ}\text{C} & \rightarrow +25^{\circ}\text{C} & \rightarrow +25^{\circ}\text{C} \\ (30\text{mins}) & (5\text{mins}) & (30\text{mins}) & (5\text{mins}) \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ & & & & & & & \\ $						
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- Contact Discharge: 1. Temperature ambiance : 15°C ~35°C 2. Humidity relative : 30%~60% 3. Energy Storage Capacitance(Cs+Cd) : 150pF±10% 4. Discharge Resistance(Rd) : 330 Ω±10% 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%)						
6	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration :1.5 mm Each direction (X \ Y \ Z) duration for 2 Hrs 						
7	Drop Test (Packaged)	Packing Weight (Kg) Drop Height (cm) 0 ~ 45.4 122 45.4 ~ 90.8 76 90.8 ~ 454 61 Over 454 46						

POWERTIP

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320\pm10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}C \pm 5^{\circ}C$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

